

Application Data Sheet

Application Information

Application Type:: Regular
Subject Matter:: Utility
Suggested Group Art Unit::
Sequence submission?::
Computer Readable Form
(CRF)?::
Title:: WAFER SUPPORT AND SEMICONDUCTOR
SUBSTRATE PROCESSING METHOD
Attorney Docket Number:: F-9223
Suggested Drawing Figure:: 1
Total Drawing Sheets:: 6
Small Entity:: Yes

Applicant Information

Applicant Authority Type:: Inventor
Primary Citizenship Country:: Japan
Status:: Full Capacity
Given Name:: Akira
Middle Name::
Family Name:: OKABE
City of Residence:: Ohmura-shi

State or Province of
Residence:: Nagasaki

Country of Residence:: Japan

Street of Mailing Address:: c/o Epicrew Corporation,
147-40, Masuragaharamachi

City of Mailing Address:: Ohmura-shi

State or Province of Mailing
Address:: Nagasaki

Country of Mailing Address:: Japan

Postal or Zip Code of
Mailing Address:: 856-0022

Applicant Authority Type:: Inventor

Primary Citizenship Country:: Japan

Status:: Full Capacity

Given Name:: Kazuhisa

Middle Name::

Family Name:: KAWAMOTO

City of Residence:: Ohmura-shi

State or Province of
Residence:: Nagasaki

Country of Residence:: Japan

Street of Mailing Address:: c/o Epicrew Corporation,
147-40, Masuragaharamachi

City of Mailing Address:: Ohmura-shi

State or Province of Mailing
Address:: Nagasaki

Country of Mailing Address:: Japan

Postal or Zip Code of
Mailing Address:: 856-0022

Correspondence Information

Correspondence Customer
Number:: 000028107

Representative Information

Representative Designation::	Registration number::	Name::
Primary	20,456	Frank J. Jordan

Domestic Priority Information

Application::	Continuity Type::	Parent Application::	Parent Filing Date::
This application	National Stage of	PCT/JP2004/016 567	11/09/04

Foreign Priority Information

Country::	Application Number::	Filing Date::	Priority Claimed::
Japan	2004-94230	03/29/04	Yes